

L Number	Hits	Search Text	DB	Time stamp
1	909531	(upper or top\$5 or high\$3) with layer\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:14
2	143656	((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:15
3	15969	((upper or top\$5 or high\$3) with layer\$5) with (config\$10 or custom\$10)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:48
4	631	(((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1)) same (((upper or top\$5 or high\$3) with layer\$5) with (config\$10 or custom\$10))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:16
5	345	(((upper or top\$5 or high\$3) with layer\$5) with (config\$10 or custom\$10)) with (short\$5 or fus\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:18
6	21	(((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1)) same (((((upper or top\$5 or high\$3) with layer\$5) with (config\$10 or custom\$10)) with (short\$5 or fus\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:26
7	30745	passiv\$8 adj5 layer\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:28
8	5079	(((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1)) same (passiv\$8 adj5 layer\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:28
9	214	((((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1)) same (passiv\$8 adj5 layer\$3)) same (config\$10 or custom\$10)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:29
10	72	((((((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1)) same (passiv\$8 adj5 layer\$3)) same (config\$10 or custom\$10)) same ((upper or top\$5 or high\$3) with layer\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:29

11	1154	((upper or top\$5 or high\$3) with layer\$5) with custom\$10	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:49
12	83	(((upper or top\$5 or high\$3) with layer\$5) with custom\$10) same ((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:49
	2	6718424.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 10:45
	2	6151651.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:33
	91925	(ic\$1 or integrated adj2 circuit\$2) with layer\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:34
	143656	(ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:37
	19915	short\$3 with ((upper or top\$5 or high\$3) with layer\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:37
	768	((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1) same (short\$3 with ((upper or top\$5 or high\$3) with layer\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:15
	86	(short\$3 with ((upper or top\$5 or high\$3) with layer\$1)) with delay\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:38
	32	((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1) same ((short\$3 with ((upper or top\$5 or high\$3) with layer\$1)) with delay\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:37

	18	((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$1) same ((short\$3 with ((upper or top\$5 or high\$3) with layer\$1)) with delay\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:37
	145730	(ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:37
	20128	short\$3 with ((upper or top\$5 or high\$3) with layer\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:38
	87	(short\$3 with ((upper or top\$5 or high\$3) with layer\$5)) with delay\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:38
	18	((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$5) same ((short\$3 with ((upper or top\$5 or high\$3) with layer\$5)) with delay\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:40
	779	((ic\$1 or integrated adj2 circuit\$2 or chip\$5) with layer\$5) same (short\$3 with ((upper or top\$5 or high\$3) with layer\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 09:13